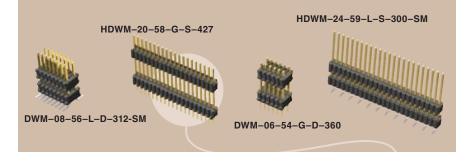


(1,27mm) .050' **DWM, HDWM SERIES**





MICRO BOARD STACKER

SPECIFICATIONS

DWM

For complete specifications see www.samtec.com?DWM

(SP.

Insulator Material: Top: Black I CP

Bottom: Natural LCP

Terminal Material: Phosphor Bronze Plating: Au or Sn over

50µ" (1,27µm) Ni Current Rating:

Operating Temp Range: -55°C to + 105°C with Tin -55°C to + 125°C with Gold

RoHS Compliant: Yes

HDWM

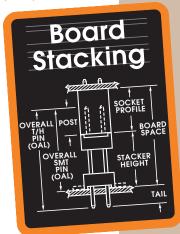
For complete specifications see www.samtec.com?HDWM

Same as DWM except not CSA rated.

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,15mm) .006" max

Mates with: SMS, SLM, RSM



01

thru

50

DWM

= Standard Board Spacer

Variable Ideal for high density "skyscraper" board stacking Choice of Surface mount or Through-hole

NO. PINS **TYPE LEAD PLATING OPTION STRIP PER ROW** STYLE

Specify LEAD

STYLE

from

chart

stacker

height

10μ" (0,25μm) Gold contact, Matte Tin on tail

–G = 10µ" (0,25µm) Gold on post, Gold flash

-S = Single Row

ROW

OPTION

-D = Double Row

"XXX" = Stacker Height Example: -250 = (6,35mm).250"

STACKER

HEIGHT

EAD TYLE	OAL	
	THROUGH- HOLE	SURFACE MOUNT
-01	(11,43) .450	(8,38) .330
-51	(10,41) .410	_
-52	(10,80) .425	_
-53	(12,83) .505	(9,78) .385
-54	(14,10) .555	(11,05) .435
-55	(15,49) .610	(12,45) .490
-56	(15,88) .625	(12,83) .505
-57	(16,51) .650	(13,46) .530
-58	(17,91) .705	(14,86) .585
-59	(19,18) .755	(15,62) .615
-60	(20,96) .825	_
-61	(26,67) 1.050	_
<u> </u>		

Note: Other Gold plating options available. Contact Samtec.

Note: These Series are non-standard, non-returnable.

of omitted pin) -SM = Surface Mount (Requires HDWM. 02 thru 40

OTHER

OPTION

"XXX"

= Polarized

Position

(Specify position

positions only.) – A

= Alignment Pin (Requires HDWM 6 positions min –D only.) Metal or plastic at Samtec discretion (N/A with -LC)

– LC

= Locking Clip (Requires HDWM. (5 positions min. -D only)
(N/A with -A)
(Manual placement required)

— F = Pick & Place Pad (Requires HDWM)

